

Two-Wire, Differential, Vibration Resistant Sensor IC with Speed and Direction Output

FEATURES AND BENEFITS

- Two-wire, pulse width output protocol
- Digital output representing target profile
- Speed and direction information of target
- Vibration tolerance
- Small signal lockout for small amplitude vibration
- Proprietary vibration detection algorithms for large amplitude vibration
- · Air gap independent switch points
- Large operating air gap capability
- Undervoltage lockout

Not to scale

- True zero-speed operation
- Wide operating voltage range
- Single-chip sensing IC for high reliability
- Robust test coverage capability with Scan Path and IDDQ measurement

PACKAGE: 4-pin SIP (suffix SH)



DESCRIPTION

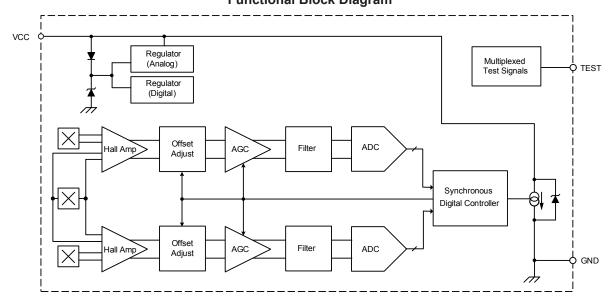
The ATS692LSH is an optimized Hall-effect integrated circuit (IC) and rare earth pellet combination that provides a user-friendly solution for direction detection and true zero-speed, digital gear tooth sensing. The small package can be easily assembled and used in conjunction with a wide variety of gear tooth sensing applications.

The IC employs patented algorithms for the special operational requirements of automotive transmission applications. The speed and direction of the target are communicated through a variable pulse width output protocol. The ATS692 is particularly adept at handling vibration without sacrificing maximum air gap capability or creating any erroneous direction information. Even higher angular vibration caused by engine cranking is completely rejected by the device. The advanced vibration detection algorithm systematically calibrates the sensor IC on the initial teeth of true target rotation and not on vibration, always guaranteeing an accurate signal in running mode.

Advanced signal processing and innovative algorithms make the ATS692 an ideal solution for a wide range of speed and direction sensing needs.

This device is available in a lead (Pb) free 4-pin SIP package with a 100% matte tin plated leadframe.

Functional Block Diagram



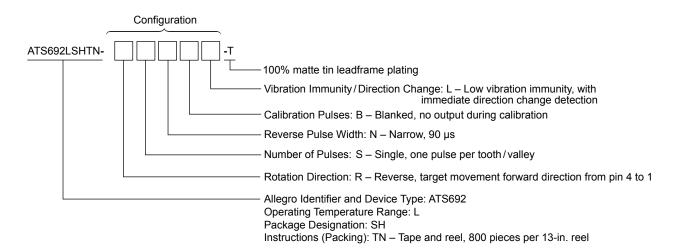
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SELECTION GUIDE

Part Number	Packing*	Direction Change Function	Vibration Immunity (Running Mode)	
ATS692LSHTN-RSNBL-T	800 pieces per reel	First edge direction	0.12 × T _{TARGET}	



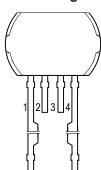
*Contact AllegroTM for additional packing options.



ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	Notes	Rating	Unit
Supply Voltage	V _{CC}	Refer to Power Derating section	28	٧
Reverse Supply Voltage	V _{RCC}		-18	V
Operating Ambient Temperature	T _A	L temperature range	-40 to 150	°C
Maximum Junction Temperature	T _J (max)		165	°C
Storage Temperature	T _{stg}		-65 to 170	°C

Pinout Diagram



Terminal List Table

Number	Name	Function		
1	VCC	Supply voltage		
2	TEST	Test pin: float *		
3	TEST	Test pin: float *		
4	GND	Ground		

*Connection of TEST to VCC and/or GND may cause undesired additional current consumption in the IC.



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OPERATING CHARACTERISTICS: Valid at throughout full operating and temperature ranges; using Reference Target 60-0; unless otherwise specified

Characteristic	Symbol	Test Conditions	Min.	Typ. [1]	Max.	Unit
GENERAL ELECTRICAL CHARAC	TERISTICS					
Supply Voltage [2]	V _{CC}	Operating, T _J < T _J (max)	4.0	-	24	V
Under Voltage Lockout	V _{CC(UV)}	$V_{CC} 0 \rightarrow 5 \text{ V or } 5 \rightarrow 0 \text{ V}$	_	3.6	3.95	V
Reverse Supply Current [3]	I _{RCC}	V _{CC} = V _{RCC} (max)	_	_	-10	mA
Supply Zener Clamp Voltage	V _{Z(SUPPLY)}	$I_{CC} = I_{CC}(max) + 3 \text{ mA}, T_A = 25^{\circ}\text{C}$	28	_	_	V
	$I_{CC(LOW)}$	Low-current state (Running mode)	5.0	_	8.0	mA
Supply Current	I _{CC(HIGH)}	High-current state (Running mode)	12.0	_	16.0	mA
	$I_{CC(SU)(LOW)}$	Startup current level (Power-On mode)	5.0	_	8.5	mA
Supply Current Ratio	I _{CC(HIGH)} / I _{CC(LOW)}	Measured as ratio of high current to low current	1.9	_	_	_
Test Pins Zener Clamp Voltage [4]	V _{Z(TEST)}		_	6	_	V
OUTPUT STAGE						
Output Slew Rate	SR _{OUT}	$\begin{array}{c} R_L = 100~\Omega,~C_L = 10~pF;~I_{CC(HIGH)} \rightarrow I_{CC(LOW)},\\ I_{CC(LOW)} \rightarrow I_{CC(HIGH)},~10\%~to~90\%~points \end{array}$	7.0	16	_	mA/µs
OUTPUT PULSE CHARACTERIST	ICS [5]				•	
Pulse Width (Forward Rotation)	t _{w(FWD)}		38	45	52	μs
Pulse Width (Reverse Rotation)	t _{w(REV)}		76	90	104	μs
GENERAL OPERATING CHARACT						
Operate Point	B _{OP}	% of peak-to-peak V _{PROC}	_	69	_	%
Release Point	B _{RP}	% of peak-to-peak V _{PROC}	_	31	_	%
Operating Frequency (Forward Rotation)	f _{FWD}		0	_	12	kHz
Operating Frequency (Reverse Rotation) [6]	f _{REV}		0	_	7	kHz
DAC CHARACTERISTICS	<u>'</u>				'	
Allowable User-Induced Offset	B _{OFFSET}	Magnitude valid for both differential magnetic channels	-60	_	60	G
PERFORMANCE CHARACTERIST	ics					
Air Gap Range	AG	Using Allegro Reference Target 60-0	0.5	_	2.75	mm
Vibration Immunity (Startup)	err _{VIB(SU)}	See figure 1	1.0 × T _{TARGET}	-	_	degrees
Vibration Immunity (Running Mode)	err _{VIB}	See figure 1	0.12 × T _{TARGET}	_	_	degrees

Continued on the next page...

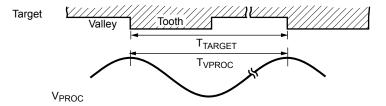


Two-Wire, Differential, Vibration Resistant Sensor IC with Speed and Direction Output

OPERATING CHARACTERISTICS (continued): Valid at throughout full operating and temperature ranges; using Reference Target 60-0; unless otherwise specified

Characteristic	Symbol	Test Condition	Min.	Typ. ¹	Max.	Unit	
CALIBRATION							
First Direction Output Pulse [7]		Amount of target rotation (constant direction) following power-on until first electrical	AG ≥ 0.5 mm AG < 2.25 mm	-	2 × T _{TARGET}	<3 × T _{TARGET}	deg.
	output pulse of either	output pulse of either $t_{w(FWD)}$ or $t_{w(REV)}$, see figure 1	AG ≥ 2.25 mm AG ≤ 2.75 mm	_	2.5 × T _{TARGET}	<4 × T _{TARGET}	deg.
First Direction Pulse Output Following Direction Change	N _{CD}			_	1	_	switch- point
First Direction Pulse Output Following Running Mode Vibration		Amount of target rotation (constant direction) following event until first electrical output pulse of either $t_{\text{W(FWD)}}$ or $t_{\text{W(REV)}}$, see figure 1		ı	_	1.25 × T _{TARGET}	deg.

^[1] Typical values are at T_A = 25°C and V_{CC} = 12 V. Performance may vary for individual units, within the specified maximum and minimum limits.



 V_{PROC} = the processed analog signal of the sinusoidal magnetic input (per channel) T_{TARGET} = period between successive sensed target mechanical edges of the same

orientation (either both rising or both falling)

Figure 1. Definition of T_{TARGET}



^[2] Maximum voltage must be adjusted for power dissipation and junction temperature; see Power Derating section.

^[3] Negative current is defined as conventional current coming out of (sourced from) the specified device terminal.

^[4] Sustained voltages beyond the clamp voltage may cause permanent damage to the IC.

^[5] Load circuit is R_L = 100 Ω and C_L = 10 pF. Pulse duration measured at a threshold of ($I_{CC(HIGH)} + I_{CC(LOW)}$) / 2.

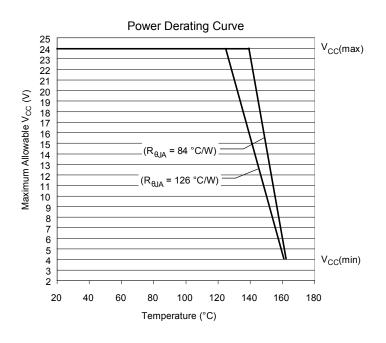
^[6] Maximum of Operating Frequency (Reverse Rotation) is determined by satisfactory separation of output pulses: $I_{CC(LOW)}$ of $t_{w(FWD)}$ (min). If the customer can resolve lower low-state durations, maximum f_{REV} may be increased.

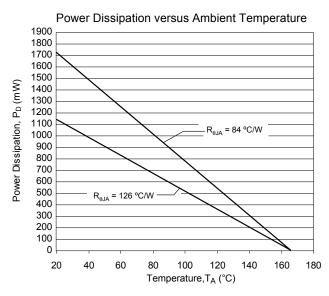
^[7] Power-on frequency ≤ 200 Hz. Higher power-on frequencies may require more input magnetic cycles until output edges are achieved.

THERMAL CHARACTERISTICS: May require derating at maximum conditions; see Power Derating section

Characteristic	Symbol Test Conditions*			Unit
		Single layer PCB, with copper limited to solder pads	126	°C/W
Package Thermal Resistance	$R_{ heta JA}$	Single layer PCB, with copper limited to solder pads and 3.57 in. ² (23.03 cm ²) copper area each side	84	°C/W

^{*}Additional thermal information available on the Allegro website



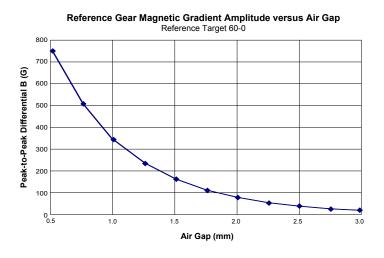


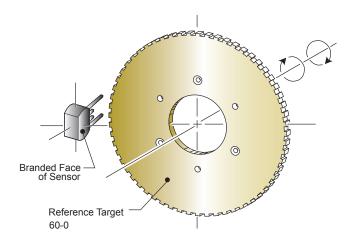


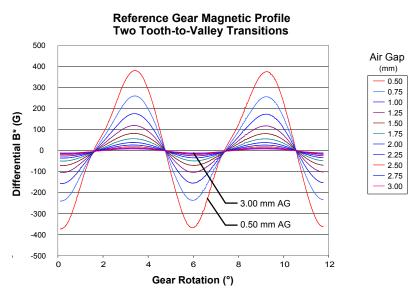
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REFERENCE TARGET 60-0 (60 TOOTH TARGET)

Characteristics	Symbol	Test Conditions	Тур.	Units	Symbol Key
Outside Diameter	D _o	Outside diameter of target	120	mm	, f D _o ¬ h _{t¬}
Face Width	F	Breadth of tooth, with respect to branded face	6	mm	F- F-
Angular Tooth Thickness	t	Length of tooth, with respect to branded face	3	deg.	The second in th
Angular Valley Thickness	t _v	Length of valley, with respect to branded face	3	deg.	
Tooth Whole Depth	h _t		3	mm	Air Gap
Material		Low Carbon Steel	_	_	Branded Face of Sensor









FUNCTIONAL DESCRIPTION

Sensing Technology

The sensor IC contains a single-chip Hall-effect circuit that supports a trio of Hall elements. These elements are used in differential pairs to provide electrical signals containing information regarding edge position and direction of target rotation. The ATS692 is intended for use with ferromagnetic targets.

After proper power is applied to the sensor IC, it is capable of providing digital information that is representative of the magnetic features of a rotating target. The waveform diagrams in figure 3 present the automatic translation of the target profiles, through their induced magnetic profiles, to the digital output signal of the sensor IC.

Direction Detection

The sensor IC compares the relative phase of its two differential channels to determine in which direction the target is moving. The relative switching order is used to determine the direction, which is communicated through the output protocol.

Data Protocol Description

When a target passes in front of the device (opposite the branded face of the package case), the ATS692 generates an output pulse for each tooth of the target. Speed information is provided by the output pulse rate, while direction of target rotation is provided by the duration of the output pulses. The sensor IC can sense target movement in both the forward and reverse directions.

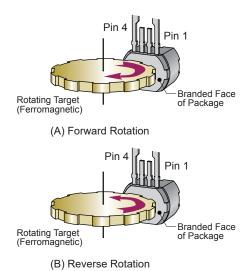


Figure 2. Target rotation

Forward Rotation. (see panel A in figure 2) When the target is rotating such that a tooth near the sensor IC passes from pin 4 to pin 1, this is referred to as *forward rotation*. Forward rotation is indicated on the output by a $t_{w(FWD)}$ (45 µs typical) pulse width.

Reverse Rotation. (see panel B in figure 2) When the target is rotating such that a tooth passes from pin 1 to pin 4, it is referred to as *reverse rotation*. Reverse rotation is indicated on the output by pulse widths of $t_{w(REV)}$ (90 µs typical).

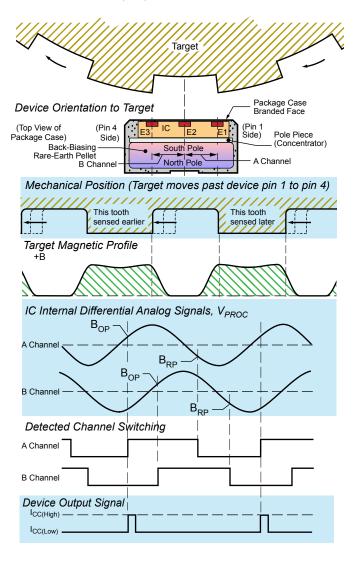


Figure 3. The magnetic profile reflects the features of the target, allowing the sensor IC to present an accurate digital output.



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Timing. As shown in figure 4, the pulse appears at the output slightly before the sensed magnetic edge traverses the package branded face. For targets in forward rotation, this shift, Δ fwd, results in the pulse corresponding to the valley with the sensed mechanical edge, and for targets in reverse rotation, the shift, Δ rev, results in the pulse corresponding to the tooth with the sensed edge. The sensed mechanical edge that stimulates output pulses is kept the same for both forward and reverse rotation by using only one channel to control output switching.

Direction Validation

Following a direction change in running mode, direction changes are immediately transmitted to the output. An example of the waveforms is shown in figure 5.

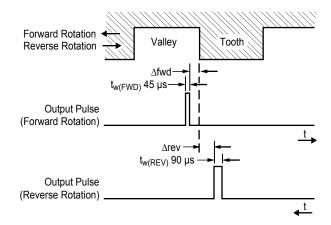


Figure 4. Output protocol

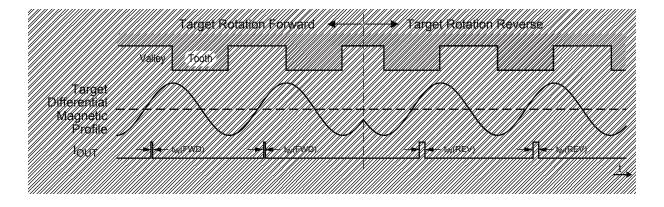


Figure 5. Example of direction change in Running mode



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Start-Up Detection / Calibration

When power is applied to the ATS692, the sensor IC internally detects the profile of the target. The gain and offset of the detected signals are adjusted during the calibration period, normalizing the internal signal amplitude for the air gap range of the device.

The Automatic Gain Control (AGC) feature ensures that operational characteristics are isolated from the effects of installation air gap variation.

Automatic Offset Adjustment (AOA) is circuitry that compensates for the effects of chip, magnet, and installation offsets. This circuitry works with the AGC during calibration to adjust V_{PROC} in the internal A-to-D range to allow for acquisition of signal peaks. AOA and AGC function separately on the two differential signal channels.

Direction information is available after calibration is complete. The output becomes active at the end of calibration. Figure 6 shows where the first output edges may occur for various starting target phases.

Vibration Detection

Algorithms embedded in the IC digital controller detect the presence of target vibration through analysis of the two magnetic input channels.

The first direction change is immediately transmitted to the output. During any subsequent vibration, the output is blanked and no output pulses occur for vibrations less than the specified vibration immunity (see figure 7). When constant rotation resumes, output pulses containing the proper direction information will resume when direction information is validated on constant target rotation.

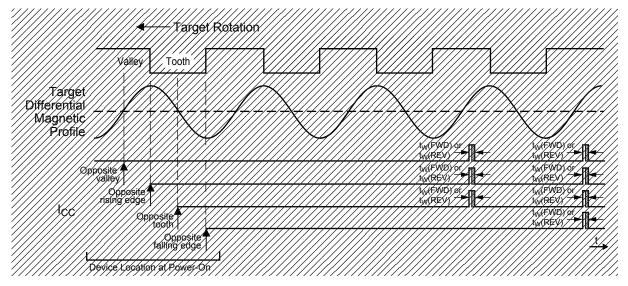


Figure 6. Start-up position effect on first device output switching

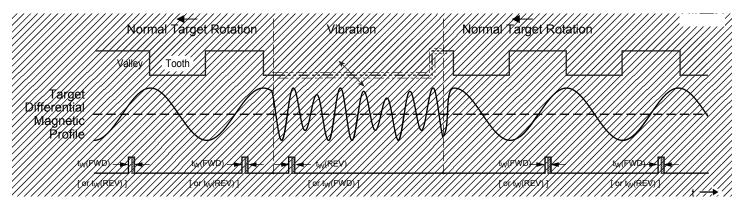


Figure 7. Output functionality in the presence of Running mode target vibration



APPLICATION INFORMATION

Power Derating

The device must be operated below the maximum junction temperature of the device, $T_{J(max)}$. Under certain combinations of peak conditions, reliable operation may require derating supplied power or improving the heat dissipation properties of the application. This section presents a procedure for correlating factors affecting operating T_J . (Thermal data is also available on the Allegro website.)

The Package Thermal Resistance, $R_{\theta JA}$, is a figure of merit summarizing the ability of the application and the device to dissipate heat from the junction (die), through all paths to the ambient air. Its primary component is the Effective Thermal Conductivity, K, of the printed circuit board, including adjacent devices and traces. Radiation from the die through the device case, $R_{\theta JC}$, is relatively small component of $R_{\theta JA}$. Ambient air temperature, T_A , and air motion are significant external factors, damped by overmolding.

The effect of varying power levels (Power Dissipation, P_D), can be estimated. The following formulas represent the fundamental relationships used to estimate T_J , at P_D .

$$P_D = V_{IN} \times I_{IN} \tag{1}$$

$$\Delta T = P_D \times R_{\theta JA} \tag{2}$$

$$T_{I} = T_{\Delta} + \Delta T \tag{3}$$

For example, given common conditions such as: T_A = 25°C, V_{CC} = 12 V, I_{CC} = 6.5 mA, and $R_{\theta JA}$ = 126 °C/W, then:

$$P_D = V_{CC} \times I_{CC} = 12 \text{ V} \times 6.5 \text{ mA} = 78 \text{ mW}$$

 $\Delta T = P_D \times R_{\theta JA} = 78 \text{ mW} \times 126 \text{ °C/W} = 9.8 \text{°C}$
 $T_J = T_A + \Delta T = 25 \text{°C} + 9.8 \text{°C} = 34.8 \text{°C}$

A worst-case estimate, $P_D(max)$, represents the maximum allowable power level ($V_{CC}(max),\,I_{CC}(max)$), without exceeding $T_J(max)$, at a selected $R_{\theta JA}$ and $T_A.$

Example: Reliability for V_{CC} at T_A =150°C, package SH, using a single-layer PCB.

Observe the worst-case ratings for the device, specifically: $R_{\theta JA} = 126$ °C/W, $T_J(max) = 165$ °C, $V_{CC}(max) = 24$ V, and $I_{CC}(mean) = 13$ mA. (Note: At maximum target frequency, $I_{CC(LOW)} = 8$ mA, $I_{CC(HIGH)} = 16$ mA, and maximum pulse widths, the result is a duty cycle of 62.4% and a worst case $I_{CC}(mean)$ of 13 mA.)

Calculate the maximum allowable power level, $P_D(max)$. First, invert equation 3:

$$\Delta T_{\text{max}} = T_{\text{J}}(\text{max}) - T_{\text{A}} = 165 \,^{\circ}\text{C} - 150 \,^{\circ}\text{C} = 15 \,^{\circ}\text{C}$$

This provides the allowable increase to T_J resulting from internal power dissipation. Then, invert equation 2:

$$P_D(max) = \Delta T_{max} \div R_{\theta JA} = 15^{\circ}C \div 126^{\circ}C/W = 119 \text{ mW}$$

Finally, invert equation 1 with respect to voltage:

 $V_{CC}(est) = P_D(max) \div I_{CC}(max) = 119 \text{ mW} \div 13 \text{ mA} = 9.2 \text{ V}$ The result indicates that, at T_A , the application and device can dissipate adequate amounts of heat at voltages $\leq V_{CC}(est)$.

Compare $V_{CC}(\text{est})$ to $V_{CC}(\text{max})$. If $V_{CC}(\text{est}) \leq V_{CC}(\text{max})$, then reliable operation between $V_{CC}(\text{est})$ and $V_{CC}(\text{max})$ requires enhanced $R_{\theta JA}$. If $V_{CC}(\text{est}) \geq V_{CC}(\text{max})$, then operation between $V_{CC}(\text{est})$ and $V_{CC}(\text{max})$ is reliable under these conditions.

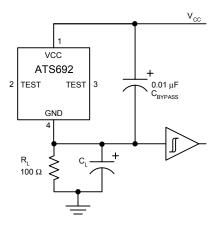


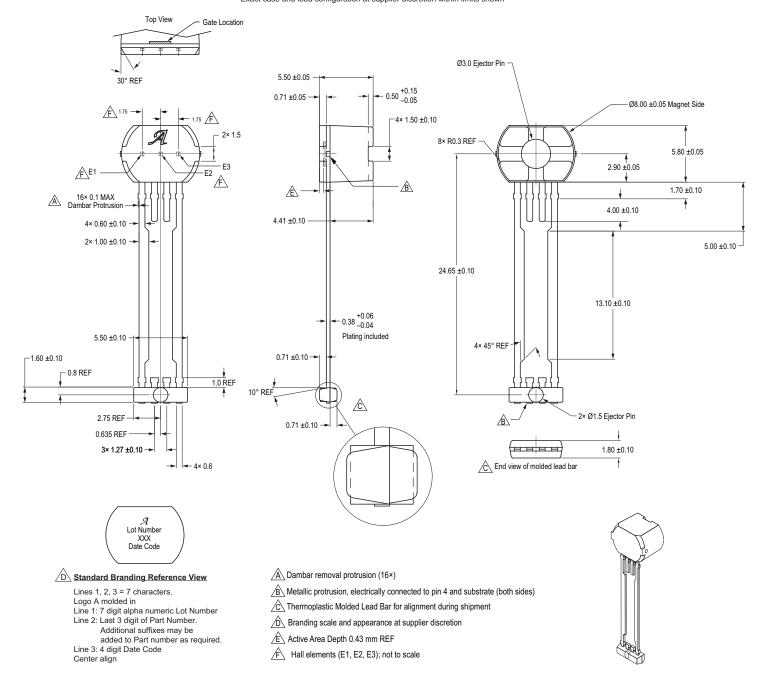
Figure 8. Typical application circuit



Package SH, 4-Pin SIP

For Reference Only – Not for Tooling Use (Reference DWG-0000393)

(Reference DWG-0000393)
Dimensions in millimeters. NOT TO SCALE.
Dimensions exclusive of mold flash, gate burrs, and dambar protrusions
Exact case and lead configuration at supplier discretion within limits shown





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REVISION HISTORY

Number	Date	Description	
2	August 27, 2013	August 27, 2013 Upgrades to select graphics, T _{stg} , err _{VIB} and err _{VIB(SU)} update	
3	May 27, 2020	Minor editorial updates	
4	March 18, 2022	Updated package drawing (page 11)	

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